

DO-15

ROHS
COMPLIANT

Pb-Free

Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Open Junction chip
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed
260°C/10 seconds at terminals

Mechanical Data

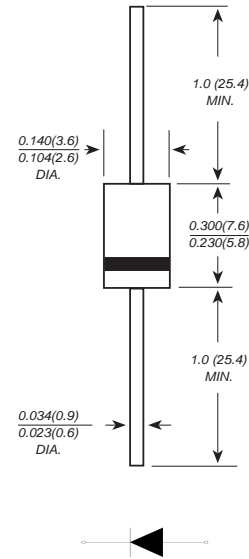
Case : Molded plastic body

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbol marking on body

Mounting Position : Any

Weight : 0.0116 ounce, 0.33 grams



Dimensions in inches and (millimeters)

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	HER 201	HER 202	HER 203	HER 204	HER 205	HER 206	HER 207	HER 208	UNITS	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	300	400	600	800	1000	V	
Maximum RMS voltage	V_{RMS}	35	70	140	210	280	420	560	700	V	
Maximum DC blocking voltage	V_{DC}	50	100	200	300	400	600	800	1000	V	
Maximum average forward rectified current at $T_L=100^\circ\text{C}$	$I_{(AV)}$	2.0								A	
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	60.0								A	
Maximum instantaneous forward voltage at 2.0A	V_F	1.0			1.4		1.7			V	
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=100^\circ\text{C}$	I_R	5.0 200								μA	
Maximum reverse recovery time (Note 1)	T_{rr}	50					75				ns
Typical junction capacitance (Note 2)	C_J	50.0								pF	
Typical thermal resistance	R_{qJA}	75.0								$^\circ\text{C}/\text{W}$	
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150								$^\circ\text{C}$	

Note: 1. Reverse recovery time test condition: $I_F=0.5\text{A}$ $I_R=1.0\text{A}$ $I_{rr}=0.25\text{A}$
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

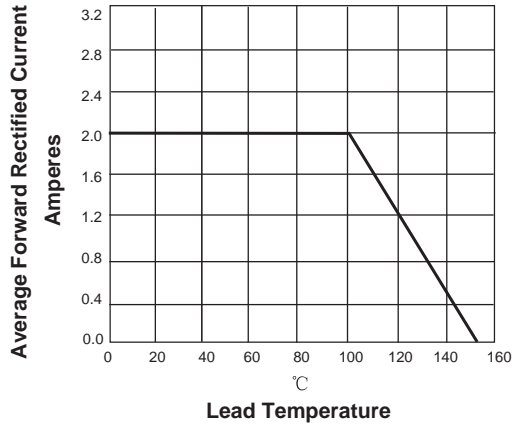


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

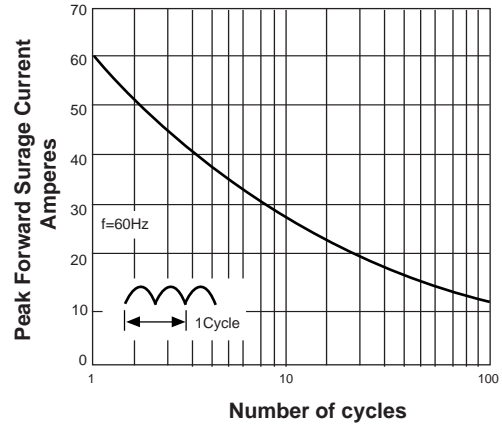


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

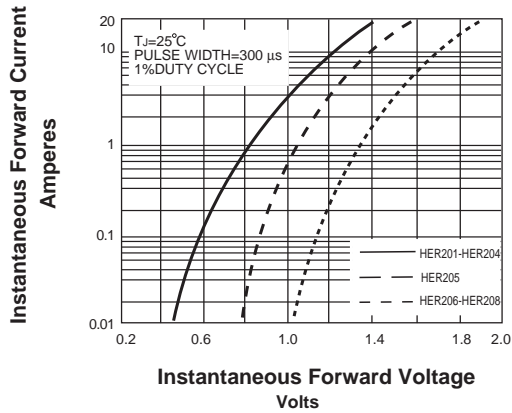
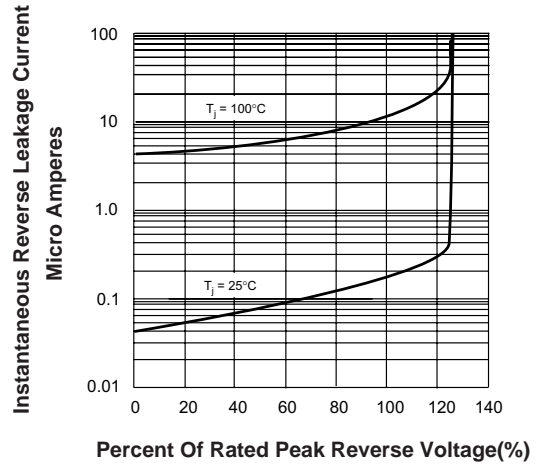
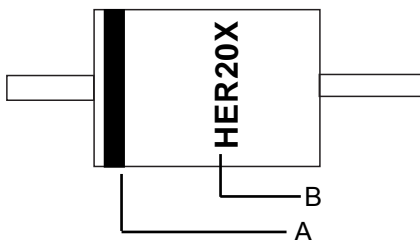


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS

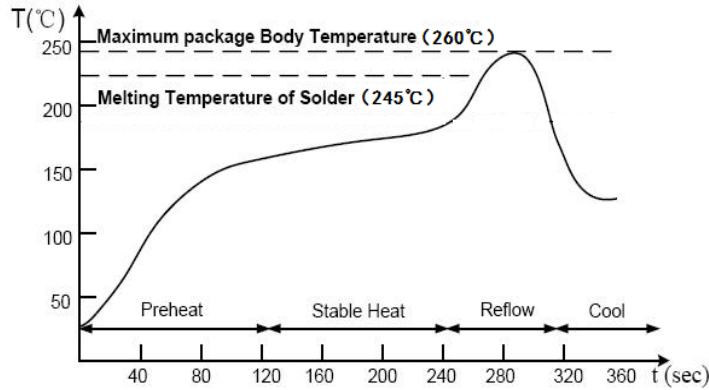


Marking



Symbol	Explanation
A	Color Band Denotes Cathode
B	Product Name,X : 1.2.....8

Suggested Soldering Temperature Profile

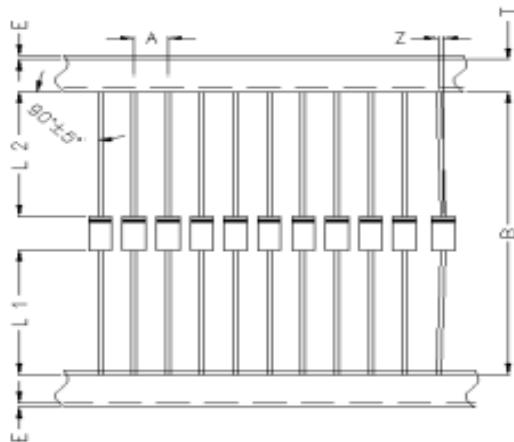


Note

- ◆ Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- ◆ The device can be exposed to a maximum temperature of 260°C for 10 seconds.
- ◆ Devices can be cleaned using standard industry methods and solvents.
- ◆ If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

Package Information

Taping Specifications



Item	Symbol	Specifications(mm)
Component Pitch	A	5.0±0.5
Inner Tape Pitch	B	52.4±1.5
Component alignment	Z	1.2 Max
Tape width	T	6.0±0.5
Exposed adhesive	E	0.8 Max
Body eccentricity	L1-L2	1.0 Max

Ammunition Package Specifications

Package	Inner Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
DO - 15	255*150*75	3	420*276*312	30